EAST Search History

EAST Search History (Prior Art)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	"256"".""686".ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:57
L2	4230	257/686.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:57
L3	3388	257/723.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:57
L4	3882	257/737.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:57
L5	2958	257/738.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:57
L6	3281	257/777.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:58
L7	1968	257/780.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:58
L8	155	257/E25.01.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:58
L9	4724	257/E25.013.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:58

L10	17214	2 or 3 or 4 or 5 or 6 or 7 or 8 or 9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2010/11/30 08:58
L11	7193	10 and @ad<=''20051121''	USPAT	ADJ	ON	2010/11/30 08:58
L12	5016	11 and (wiring or trace or circuitry)	USPAT	ADJ	ON	2010/11/30 09:04
L13	4679	12 and (active layer or circuit)	USPAT	ADJ	ON	2010/11/30 09:05
L14	144	13 and (through near electrode)	USPAT	ADJ	ON	2010/11/30 09:05
S2	2	''20030062620''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/26 16:26
S3	2	''5952718''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/26 16:26
S4	44	10-223833	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/26 16:27
S5	14	JP 10-223833	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/26 16:27
S6	1	''10577863''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 15:47
S7	2	''20030183943''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:29
S8	2	''20020109236''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:29
S9	2	''20030060034''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:30

S10	3315	257/686.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:33
S11	1605	post near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:34
S12	1147	multilayer near wiring near layer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:34
S13	0	S10 and S11 and S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:35
S14	12	S10 and S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:35
S15	874761	stack or stacked	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:36
S16	9252	(stack or stacked) near semiconductor	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:36
S17	8	multlayer near wiring	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:37
S18	13337	multilayer near wiring	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:37
S19	88	S16 and S18	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:38

S20	4317	257/E25.013.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:46
S21	10	S20 and S12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:46
S22	83	S20 and S18	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:48
S23	11	257/e25.017.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 16:56
S24	4183	through near hole near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 17:13
S25	72	S20 and S24	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 17:13
S26	126	439/658.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 18:49
S27	1605	post near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:03
S28	2602	257/777.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:24
S29	14	S28 and S27	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:24

S30	2	''20070007639''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:29
S31	4183	through near hole near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:40
S32	25	S31 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:40
S33	8	S31 and S27	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/03 19:48
S34	2	''6503773''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 09:59
S35	0	(''2008/0061402'').URPN.	USPAT	ADJ	ON	2009/03/04 10:06
S36	1324	blind near vias	USPAT	ADJ	ON	2009/03/04 10:15
S37	2602	257/777.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 10:15
S38	10	S36 and S37	USPAT	ADJ	ON	2009/03/04 10:15
S39	1349	(ball\$1 or bump\$1) and S37	USPAT	ADJ	ON	2009/03/04 10:16
S40	183360	wiring	USPAT	ADJ	ON	2009/03/04 10:17
S41	613	S39 and S40	USPAT	ADJ	ON	2009/03/04 10:21
S42	613	S41 and S37	USPAT	ADJ	ON	2009/03/04 10:21
S43	1605	post near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 10:29
S44	8	S42 and S43	USPAT	ADJ	ON	2009/03/04 10:29

S45	104947	insulating near layer	USPAT	ADJ	ON	2009/03/04 10:35
S46	101	S43 and S45	USPAT	ADJ	ON	2009/03/04 10:35
S47	2	''6355501''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 10:45
S48	1	"5907178".PN.	USPAT; USOCR	ADJ	ON	2009/03/04 10:46
S49	1	"6355501".PN.	USPAT; USOCR	ADJ	ON	2009/03/04 10:46
S50	1	''7259454''.PN.	USPAT; USOCR	ADJ	ON	2009/03/04 10:46
S51	1	''20050212126''.PN.	US-PGPUB	ADJ	ON	2009/03/04 10:48
S52	1	''20050276299''.PN.	US-PGPUB	ADJ	ON	2009/03/04 10:48
S53	1	''20060267206''.PN.	US-PGPUB	ADJ	ON	2009/03/04 10:48
S54	86554	through near electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:09
S55	42	S39 and S54	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:09
S56	0	2009/0001544	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:17
S57	2	''20090001544''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:17
S58	1	''11917470''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:48
S59	6	''11197470''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 11:49

S60	2	''6847275''.pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/04 13:57
S61	238859	metal near plate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:00
S62	9271	insulating near holes	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:00
S63	500	S61 and S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:00
S64	63	S61 with S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:00
S65	4	interposer near S61	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:08
S66	2	S64 and (257/777.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:13
S67	1	S64 and (257/686.ccls.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:14
S68	17307	S61 and ((power supply) or (ground potential))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:48
S69	131	S68 and S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 10:48

S70	473	interposer and S61	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 11:03
S71	10	S70 and S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 11:03
S72	10	S70 and S62	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/03/05 11:47
S73	1	''20060267206''.PN.	US-PGPUB	ADJ	ON	2009/10/07 16:10
S74	1	''20050276299''.PN.	US-PGPUB	ADJ	ON	2009/10/07 16:10
S75	1	''20050212126''.PN.	US-PGPUB	ADJ	ON	2009/10/07 16:10
S76	1	''7259454''.PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:10
S77	1	"6355501".PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:11
S78	1	''5907178''.PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:11
S79	6	(''6774478'').URPN.	USPAT	ADJ	ON	2009/10/07 16:35
S80	1	''6525942''.PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:46
S81	1	"6493229".PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:46
S82	1	"5579207".PN.	USPAT; USOCR	ADJ	ON	2009/10/07 16:46
S83	68	(''5579207'').URPN.	USPAT	ADJ	ON	2009/10/07 16:47
S84	1996	257/686.ccls.	USPAT	ADJ	ON	2009/10/07 17:04
S85	109	257/e25.006.ccls.	USPAT	ADJ	ON	2009/10/07 17:04
S86	1900	257/e25.013.ccls.	USPAT	ADJ	ON	2009/10/07 17:04
S87	3249	S84 or S85 or S86	USPAT	ADJ	ON	2009/10/07 17:04
S88	2872	S87 and @ad<=''20051121''	USPAT	ADJ	ON	2009/10/07 17:05
S89	2655	S88 and (circuit or active near3 (layer or area))	USPAT	ADJ	ON	2009/10/07 17:06

S90	1102	S88 and ((circuit or active) near3 (layer or area))	USPAT	ADJ	ON	2009/10/07 17:06
S91	473	S90 and wiring	USPAT	ADJ	ON	2009/10/07 17:07
S92	294	257/621.ccls.	USPAT	ADJ	ON	2009/10/07 17:19
S93	13	S91 and S92	USPAT	ADJ	ON	2009/10/07 17:19
S94	1	(''6388320'').URPN.	USPAT	ADJ	ON	2009/10/07 17:40
S95	1	''5825080''.PN.	USPAT; USOCR	ADJ	ON	2009/10/07 17:40
S96	1	"5793105".PN.	USPAT; USOCR	ADJ	ON	2009/10/07 17:41
S97	1	''5382827''.PN.	USPAT; USOCR	ADJ	ON	2009/10/07 17:41
S98	6	(''6774478'').URPN.	USPAT	ADJ	ON	2009/10/07 17:52
S99	37	10-223833	USPAT	ADJ	ON	2009/10/07 17:53
S100	0	jp10-223833	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/07 17:53
S101	22	jp 10-223833	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/07 17:53
S102	3	''20050046002''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/08 10:08
S103	3	''20060030266''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/08 16:30
S104	2	''20020030266''	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/08 16:30

11/30/2010 9:59:21 AM

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